

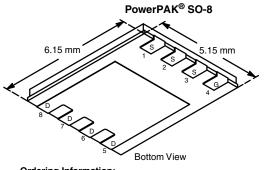
COMPLIANT

HALOGEN FREE

Vishay Siliconix

N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω) Max.	I _D (A) ^a	Q _g (Typ.)			
40	0.0024 at V _{GS} = 10 V	60	27.2 nC			
	0.0030 at V _{GS} = 4.5 V	60	21.2110			



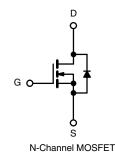
Ordering Information: SiR642DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- TrenchFET[®] Power MOSFET
- Low Qg for High Efficiency
- 100 % R_g and UIS Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Synchronous Rectification
- DC/DC Converter



ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, unle	ess otherwise not	ed)		
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	40	V		
Gate-Source Voltage	V _{GS}	± 20			
	T _C = 25 °C		60 ^a		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		60 ^a		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	35.4 ^{b, c}		
	T _A = 70 °C		28 ^{b, c}		
Pulsed Drain Current (t = 300 µs)		I _{DM}	100	— A	
Continuous Source-Drain Diode Current	T _C = 25 °C		60 ^a		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	5.6 ^{b, c}		
Single Pulse Avalanche Current		I _{AS}	35		
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	61.25	mJ	
	T _C = 25 °C		83	W	
Maximum Dawar Dissinction	T _C = 70 °C		53		
Maximum Power Dissipation	T _A = 25 °C	P _D	5.4 ^{b, c}		
	T _A = 70 °C		3.4 ^{b, c}		
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 150	**		
Soldering Recommendations (Peak Temperature		260			

THERMAL RESISTANCE RATINGS Symbol Parameter Typical Maximum Unit Maximum Junction-to-Ambient^{b, f} $t \le 10 s$ 18 23 R_{thJA} °C/W Maximum Junction-to-Case (Drain) Steady State 1 1.5 R_{thJC}

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. See solder profile (www.vishav.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

f. Maximum under steady state conditions is 65 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V$, $I_{D} = 250 \mu A$	40			V
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 5.1		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2		2.3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
		$V_{DS} = 40$ V, $V_{GS} = 0$ V, $T_{J} = 55$ °C			10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	50			Α
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		0.0019	0.0024	Ω
Drain-Source On-State Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.0025	0.0030	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		70		S
Dynamic ^b						
Input Capacitance	C _{iss}			4155		pF
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$		3125		
Reverse Transfer Capacitance	C _{rss}	-1		223		
T		$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 10$ A		56	84	
Total Gate Charge	Qg			27.2	41	nC
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		9.4		
Gate-Drain Charge	Q _{gd}			6.7		1
Gate Resistance	R _g	f = 1 MHz	0.2	0.75	1.5	Ω
Turn-On Delay Time	t _{d(on)}			14	28	
Rise Time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$		11	20	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		36	70	
Fall Time	t _f			9	18	
Turn-On Delay Time	t _{d(on)}			30	60	ns
Rise Time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 2 \Omega$		105	180	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 10 A, V_GEN = 4.5 V, R_g = 1 Ω		38	75	
Fall Time	t _f			12	50	
Drain-Source Body Diode Characteristic	s				<u> </u>	
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			60	
Pulse Diode Forward Current ^a	I _{SM}			1	100	A
Body Diode Voltage	V _{SD}	I _S = 5 A		0.72	1.1	V
Body Diode Reverse Recovery Time	t _{rr}			67	130	ns
Body Diode Reverse Recovery Charge	Q _{rr}			57	115	nC
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		24		ns
Reverse Recovery Rise Time	t _b			43		

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

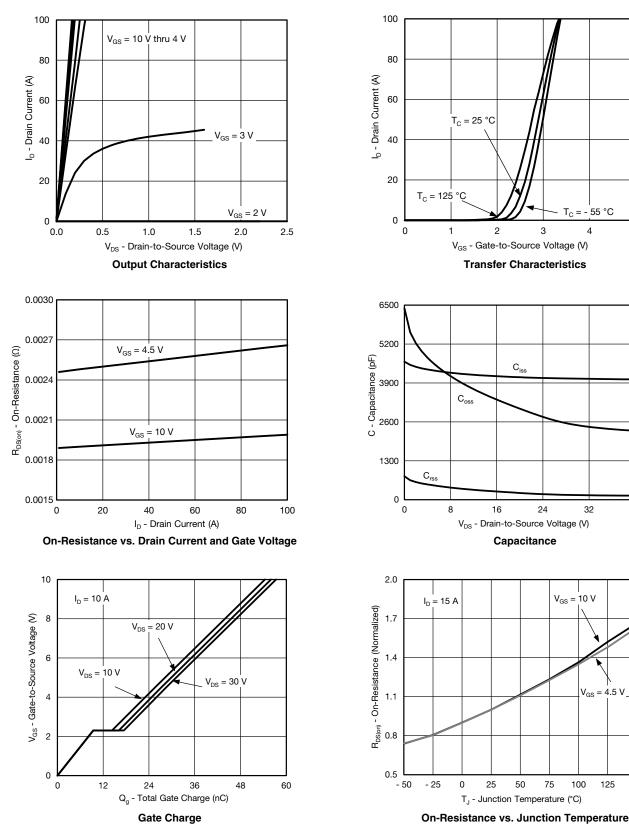


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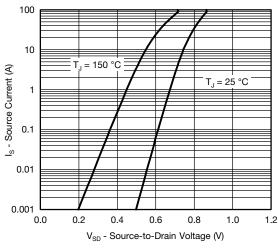
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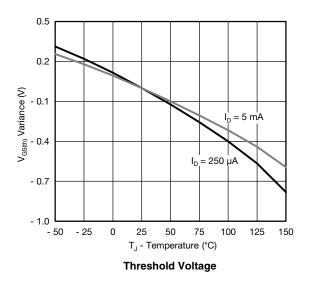
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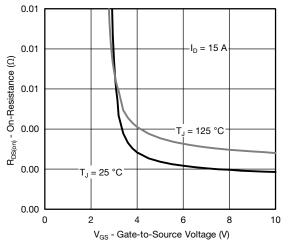


TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

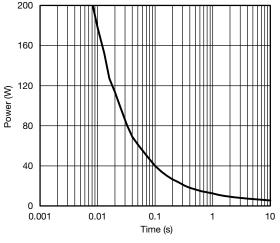


Source-Drain Diode Forward Voltage

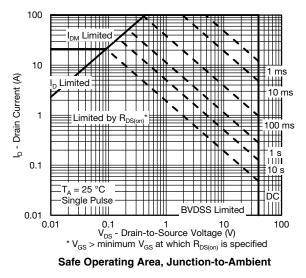




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

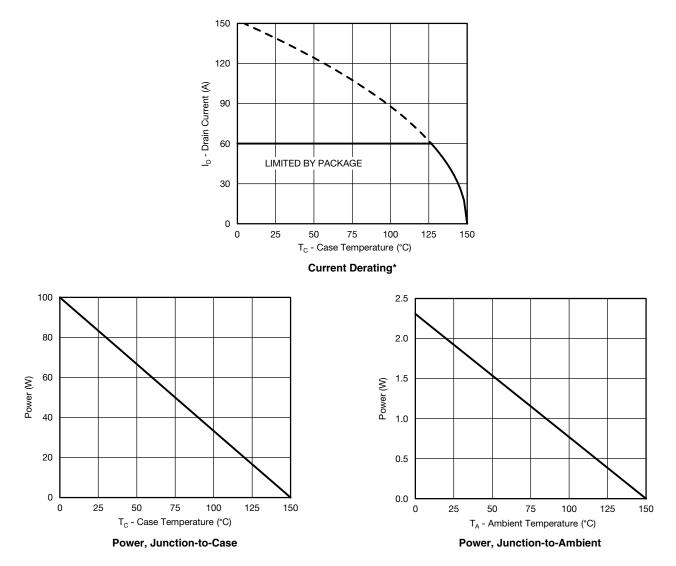


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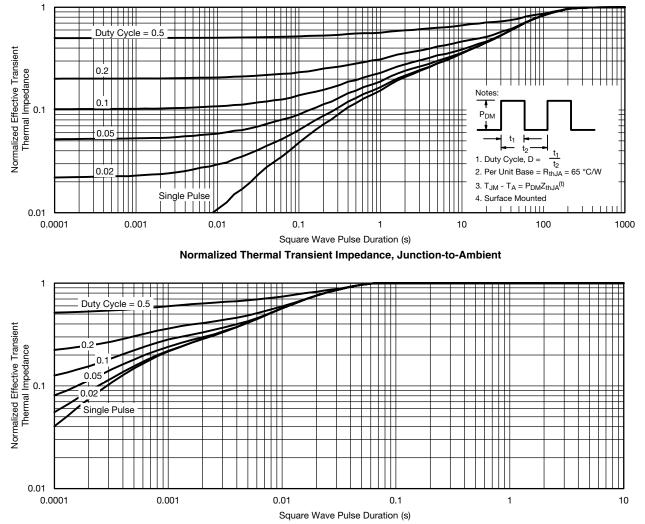


* The power dissipation P_D is based on T_{J(max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

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